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AMENDMENTS TO THE CLAIMS:

Please replace the claims with the claims provided in the listing below wherein status, amendments, additions and cancellations are indicated.

- 1. Canceled
- 2. (Previously presented) The polymer material as claimed in claim 3, wherein the fumaric diester is represented by the following formula (I):

wherein R^1 represents an alkyl group or a cycloalkyl group; R^2 represents an alkyl group, a cycloalkyl group or an aryl group; and R^1 and R^2 may be the same or different.

3. (Previously presented) A polymer material obtained through copolymerization of a monomer composition that contains, as monomers, a fumaric

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diester and an epoxy group-having (meth)acrylate represented by following formula (II):

$$CH_2 = C$$

$$C - (A)_n - C - R^3 - X$$

$$C - (A)_n - C - R^3 - X$$

wherein R³ represents an alkylene group having from 1 to 4 carbon atoms; R⁴ represents H or CH₃; A represents an alkylene oxide having from 2 to 4 carbon atoms; n indicates an integer of from 0 to 2; and X represents

4. (canceled)

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5. (previously presented) The polymer material as claimed in claim 3, wherein the epoxy group-having (meth) acrylate is represented by following formula(III):

6. (previously presented) The polymer material of low relative permittivity as claimed in claim 2, wherein the epoxy group-having (meth) acrylate is represented by following formula (III):

7. (currently amended) A film of the polymer material of claim [[1]]3.

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- 8. (currently amended) A substrate formed of the polymer material of claim [[1]]3.
- 9. (currently amended) An electronic unit formed of the polymer material of claim [[1]]3.

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